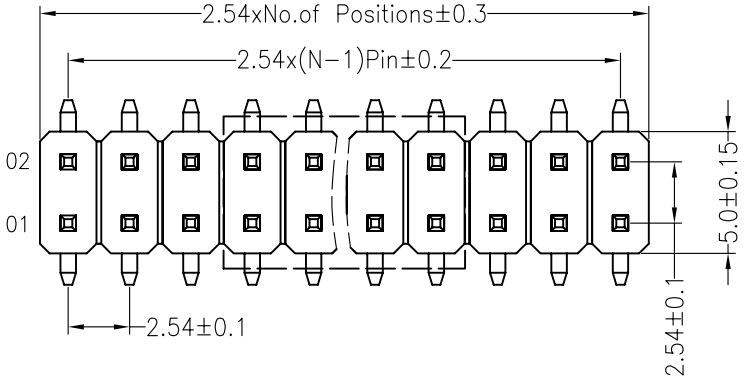
HSF RoHS

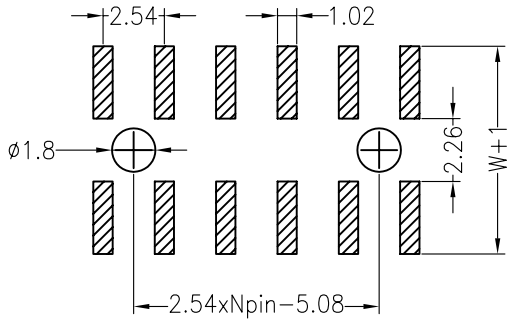
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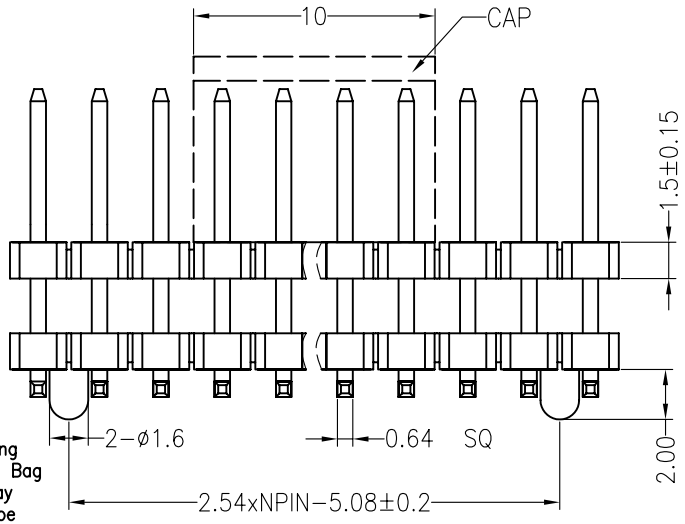
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

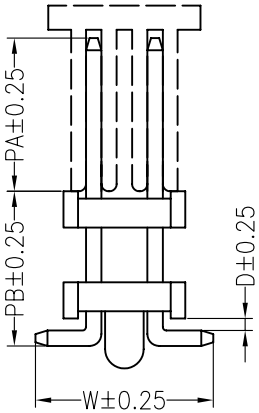
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 5 seconds)



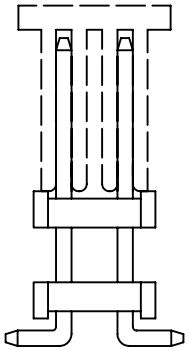
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







W= With Post



N= W/O Post

Ordering Information

1215 2 2 XX X X XX M XXX X 02

No.of Pins Per Row 2*40	Insulator Material Option A=BK−PBT B=BK−PA66 C=BK−PA6T D=BK−PA46 E=BK−PA9T F=BK−LCP	Post W=With Post N=W/O Post	Contact Plating G0:Gold Flash G1:3U" Gold G2:5U" Gold G3:10U" Gold G4:15U" Gold G5:30U" Gold S0:Gold Flash/Tin SN:Tin	Pin Length	Packing 0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap	

Dimension antitheses list					
ITEM	PA	D	PB	W	L
Standard	6.00	1.20	6.90	7.50	14.8
Alternate					

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.04.11	NEW DRAWING	

OPERATION	
X.X	±0.30
X.XX	±0.20
X.XXX	±0.10
Angle	±3°
DIM	TOL

DRAW	Liu Miao	12.04.11
CHECK		
APPROVE		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	121522XXXXXXMXXXX02
TITLE:	2.54PH 2xNpin H1.5+H1.5mm SMT